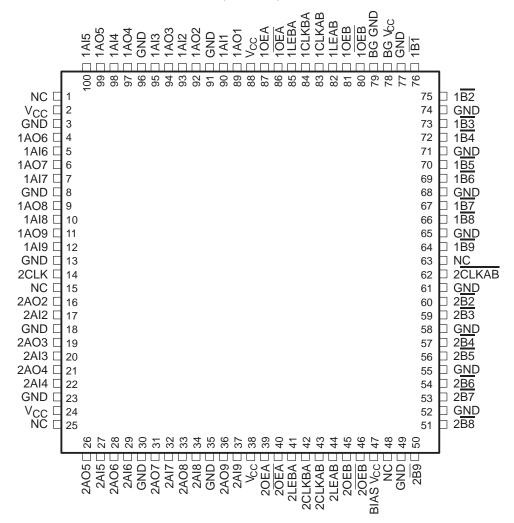
SCBS177L - OCTOBER 1993 - REVISED SEPTEMBER 1999

- Compatible With IEEE Std 1194.1-1991 (BTL)
- TTL A Port, Backplane Transceiver Logic (BTL) B Port
- Open-Collector B-Port Outputs Sink 100 mA
- BIAS V_{CC} Minimizes Signal Distortion During Live Insertion or Withdrawal

- High-Impedance State During Power Up and Power Down
- B-Port Biasing Network Preconditions the Connector and PC Trace to the BTL High-Level Voltage
- TTL-Input Structures Incorporate Active Clamping to Aid in Line Termination
- Packaged in Plastic High-Power Low-Profile Quad Flatpack

PCA PACKAGE (TOP VIEW)



NC - No internal connection



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SCBS177L - OCTOBER 1993 - REVISED SEPTEMBER 1999

description

The SN74FB1651 device contains an 8-bit and a 9-bit transceiver with a buffered clock. The clock and the transceivers are designed to translate signals between TTL and backplane transceiver-logic (BTL) environments. It is designed specifically to be compatible with IEEE Std 1194.1-1991.

The \overline{B} port operates at BTL-signal levels. The open-collector \overline{B} ports are specified to sink 100 mA. Two output enables (OEB and \overline{OEB}) are provided for the \overline{B} outputs. When OEB is low, \overline{OEB} is high, or V_{CC} is less than 2.1 V, the \overline{B} port is turned off.

The A port operates at TTL-signal levels. The A outputs reflect the inverse of the data at the \overline{B} port when the A-port output enable (OEA) is high. When OEA is low or when V_{CC} is less than 2.1 V, the A outputs are in the high-impedance state.

BIAS V_{CC} establishes a voltage between 1.62 V and 2.1 V on the BTL outputs when V_{CC} is not connected.

BG V_{CC} and BG GND are the supply inputs for the bias generator.

The SN74FB1651 is characterized for operation from 0°C to 70°C.

Function Tables

TRANSCEIVER

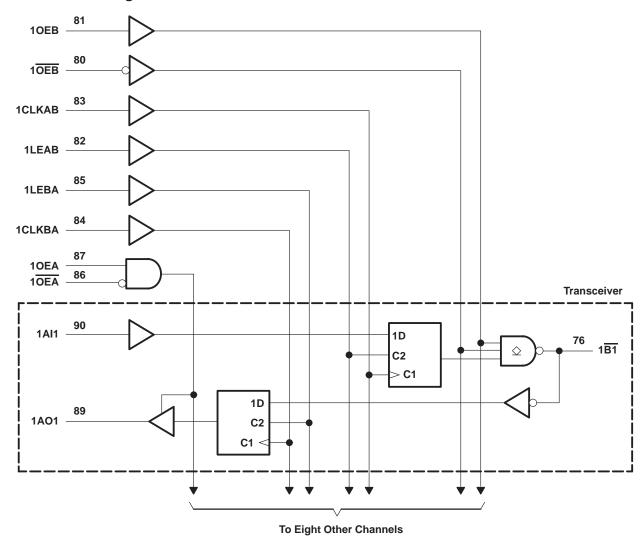
	INP	UTS		FUNCTION				
OEA	OEA	OEB	OEB	FUNCTION				
Х	Χ	Н	L	A data to B bus				
L	Н	Χ	Х	B data to A bus				
L	Н	Н	L	Ā data to B bus, B data to A bus				
Х	Χ	L	Х	D hus isolation				
Х	Χ	Χ	Н	B-bus isolation				
Н	Х	Х	Χ	A-bus isolation				
X	L	Χ	Χ	A-bus isolation				

STORAGE MODE

INP	UTS	FUNCTION			
LE	CLK	FUNCTION			
Н	Х	Transparent			
L	\uparrow	Store data			
L	L	Storage			

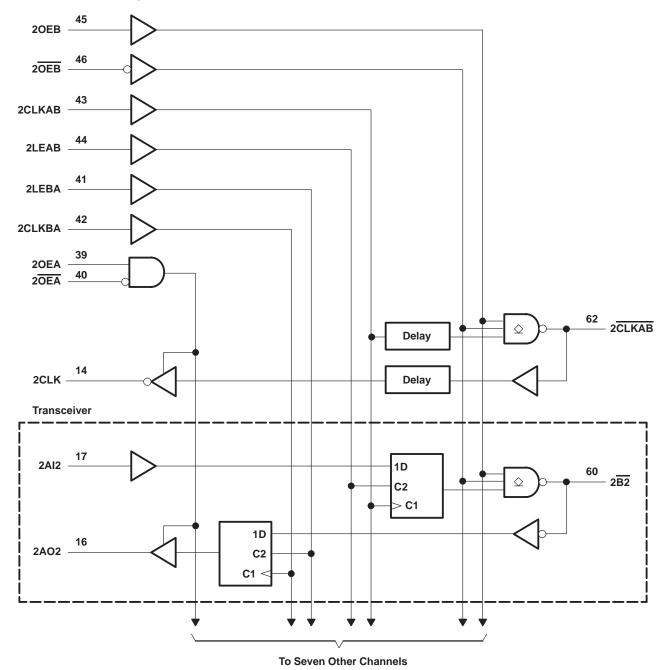


functional block diagram



SCBS177L - OCTOBER 1993 - REVISED SEPTEMBER 1999

functional block diagram (continued)





SCBS177L - OCTOBER 1993 - REVISED SEPTEMBER 1999

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC} , BIAS V _{CC} , BG V _{CC}	0.5 V to 7 V
Input voltage range, V _I : Except B port	1.2 V to 7 V
B port	–1.2 V to 3.5 V
Voltage range applied to any \overline{B} output in the disabled or power-off state, V_O	0.5 V to 3.5 V
Voltage range applied to any output in the high state, VO	0.5 V to V _{CC}
Input clamp current, I _{IK} : Except B port	–40 mA
	–18 mA
Current applied to any single output in the low state, IO: A port	48 mA
B port	200 mA
Package thermal impedance, θ_{JA} (see Note 1)	22°C/W
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 2)

			MIN	NOM	MAX	UNIT	
V _{CC} , BG V _{CC} , BIAS V _{CC}	V _{CC} , BG V _{CC} , Supply voltage BIAS V _{CC}				5.5	٧	
VIH	High level input voltage	B port	1.62		2.3	V	
	High-level input voltage	Except B port	2				
	Low level input veltage	B port	0.75		1.47	V	
VIL	Low-level input voltage Except B port				0.8	V	
lik	Input clamp current				-18	mA	
loh	High-level output current	A port			-3	mA	
lOL	Low level output ourrent	A port			24		
	Low-level output current B port				100	mA	
T _A Operating free-air temperature			0		70	°C	

NOTE 2: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



SCBS177L - OCTOBER 1993 - REVISED SEPTEMBER 1999

electrical characteristics over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS			TYP [†]	MAX	UNIT	
V	B port	V _{CC} = 4.5 V,	I _I = -18 mA			-1.2	V	
VIK	Except B port	V _{CC} = 4.5 V,	I _I = -40 mA			-0.5	V	
Va	AO port	V 45V	$I_{OH} = -1 \text{ mA}$				V	
VOH		V _{CC} = 4.5 V	$I_{OH} = -3 \text{ mA}$	2.5	3.3		\ \ \	
VOL	AO port	$V_{CC} = 4.5 \text{ V},$	$I_{OL} = 24 \text{ mA}$		0.35	0.5		
	B	V _{CC} = 4.5 V	I _{OL} = 80 mA	0.75		1.1	V	
	B port	VCC = 4.5 V	I _{OL} = 100 mA			1.15	1 1	
II	Except B port	V _{CC} = 5.5 V,	V _I = 5.5 V			50	μΑ	
I _{IH} ‡	Except B port	V _{CC} = 5.5 V,	V _I = 2.7 V			50	μΑ	
. +	Except B port	V _{CC} = 5.5 V,	V _I = 0.5 V			-50	μΑ	
I _{IL} ‡	B port	$V_{CC} = 5.5 \text{ V},$	V _I = 0.75 V			-100		
lozh	AO port	V _{CC} = 5.5 V,	$V_0 = 2.7 \text{ V}$			50	μΑ	
lozL	AO port	V _{CC} = 5.5 V,	$V_0 = 0.5 V$			-50	μΑ	
lozpu	AO port	$V_{CC} = 0 \text{ to } 2.1 \text{ V},$	$V_0 = 0.5 \text{ V to } 2.7 \text{ V}$			50	μΑ	
lozpd	AO port	$V_{CC} = 2.1 \text{ V to } 0,$	$V_0 = 0.5 \text{ V to } 2.7 \text{ V}$			-50	μΑ	
ЮН	B port	$V_{CC} = 0 \text{ to } 5.5 \text{ V},$	V _O = 2.1 V			100	μΑ	
los§	A port	V _{CC} = 5.5 V,	VO = 0	-30		-150	mA	
1	A port to B port	V 55V	1- 0			100	A	
Icc	B port to A port	$V_{CC} = 5.5 \text{ V},$	IO = 0			120	mA	
C.	Al port	V _I = 0.5 V or 2.5 V			5.5		pF	
Ci	Control inputs	VI = 0.5 V 01 2.5 V			5.5			
Co	AO ports	V _O = 0.5 V or 2.5 V			5.5		pF	
C _{io}	B port per IEEE Std 1194.1-1991	V _{CC} = 0 to 5.5 V				5.5	pF	

live-insertion specifications over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS				MAX	UNIT		
I _{CC} (BIAS V _{CC})		V _{CC} = 0 to 4.5 V	$V_{B} = 0 \text{ to } 2 \text{ V},$ $V_{I} \text{ (BIAS V}_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		V- 0 to 2 V			450	μA
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	VB = 0 t0 2 V,	V (BIAS VCC) = 4.5 V to 5.5 V		10	μΑ		
VO	B port	$V_{CC} = 0$,	V_{I} (BIAS V_{CC}) = 5 V	V_{I} (BIAS V_{CC}) = 5 V			V		
		$V_{CC} = 0$,	$V_B = 1 V$,	V_I (BIAS V_{CC}) = 4.5 V to 5.5 V	-1				
lo	B port	$V_{CC} = 0 \text{ to } 5.5 \text{ V},$	OEB = 0 to 0.8 V			100	μΑ		
		$V_{CC} = 0 \text{ to } 2.2 \text{ V},$	OEB = 0 to 5 V			100			

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

[§] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

SCBS177L - OCTOBER 1993 - REVISED SEPTEMBER 1999

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

					MIN	MAX	UNIT
			MIN	MAX			
fclock	Clock frequency			150		150	MHz
t _W	Pulse duration	CLK or LE	3.3		3.3		ns
	Catua tima	Data before LE	4.8		4.8		
t _{su}	Setup time	Data before CLK↑	4.9		4.6		ns
4.	Hold time	Data after LE	1.8		1.8		
th	noid time	Data after CLK↑	1.1		1.1		ns

SCBS177L - OCTOBER 1993 - REVISED SEPTEMBER 1999

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

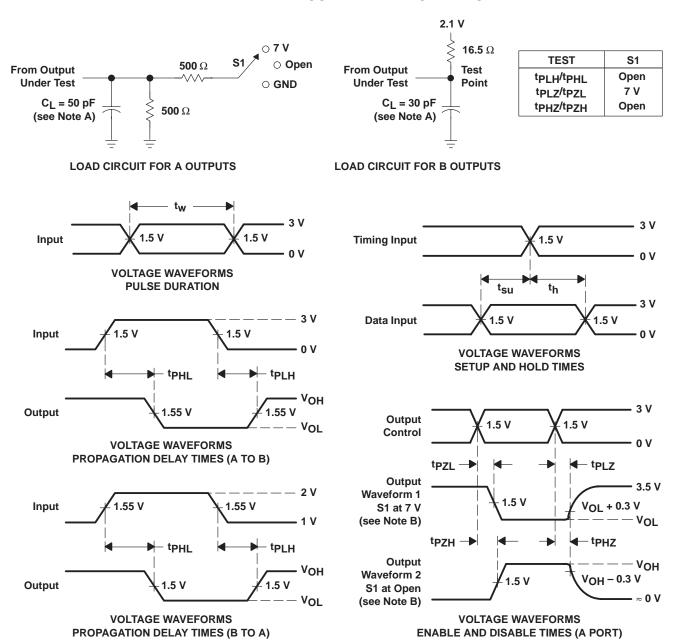
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V ₀	V _{CC} = 5 V, T _A = 25°C			MAX	UNIT
	(1141 01)	(001101)	MIN	TYP	MAX			
f _{max}			150			150		MHz
t _{PLH}	Δ1	<u> </u>	1.8	3.7	5.3	1.8	6.2	20
t _{PHL}	Al	B	2.9	4.4	6	2.9	6.6	ns
t _{PLH}	LEAB	B	2.7	4.2	5.8	2.7	6.4	no
^t PHL	LEAD	В	3.5	5	6.5	3.5	7.3	ns
t _{PLH}	CLKAB	B	2.3	3.9	5.5	2.3	6	no
^t PHL	CLNAD	В	2.9	4.5	6.1	2.9	6.7	ns
^t PLH	OCL KAD	0011/45	4.6	6.9	8.8	4.6	9.9	
^t PHL	2CLKAB	2CLKAB	4.9	6.5	8.1	4.9	8.8	ns
t _{PLH}	B	40	3.5	5.9	7.9	3.5	8	
t _{PHL}		AO	2.2	3.7	5.3	2.2	5.7	ns
t _{PLH}	LEBA	40	1.8	3.2	4.6	1.8	5.1	ns
t _{PHL}		AO	1.7	3	4.4	1.7	4.7	
tPLH	CLKBA	4.0	1.8	3.1	4.6	1.8	5.1	
t _{PHL}		AO	1.7	3.1	4.6	1.7	4.9	ns
tPLH	2CLKAB	2CLK	6.4	9.7	11.8	6.4	13.4	
t _{PHL}			4.1	6.9	8.9	4.1	10.3	ns
tPLH	055	B	2.7	4.6	6.4	2.7	6.7	
t _{PHL}	OEB		2.9	4.1	5.9	2.9	6.6	ns
^t PLH		В	2.6	4.3	6.2	2.6	6.6	ns
t _{PHL}	OEB		3.4	4.6	6.4	3.4	7	
^t PZH	254	40	1.4	2.9	4.4	1.4	4.9	
tPZL	OEA	AO	1.4	2.6	4	1.4	4.6	ns
t _{PHZ}	054	40	1.7	3.4	5.1	1.7	5.8	
tPLZ	OEA	AO	2.2	3.6	5	2.2	5.5	ns
^t PZH		40	1.7	3.3	4.7	1.7	5.5	
t _{PZL}	OEA	AO	1.7	3.1	4.4	1.7	5.1	ns
^t PHZ		40	1.5	2.9	4.5	1.5	5.1	
tPLZ	OEA	AO	2	3.1	4.6	2	4.8	ns
_	Pulse skew, CLK to B and 2	Pulse skew, CLK to B and 2CLKAB						
^t sk(p) [†]	Pulse skew, CLK to B							ns
t _{sk(p)} ‡	Pulse skew, AI to B or B to		1				ns	
t _{sk(o)} ‡	Pulse skew, Al to B or B to	AO		0.5				ns
t _t	B outputs (1.3 V to 1.8 V)		0.9	1.7		0.5	4.6	
Transition time [†]	AO outputs (10% to 90%)		0.5	2		0.4	4.2	ns
B-port input pulse rejection			1			1		ns
	. 011/							

[†] Skew values are applicable for CLK mode only.



[‡] Skew values are applicable for through mode only.

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: TTL inputs: PRR \leq 10 MHz, Z_O = 50 Ω , $t_\Gamma \leq$ 2.5 ns, $t_f \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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